



SPN90T06

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN90T06 is the N-Channel enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits where high-side switching is required.

APPLICATIONS

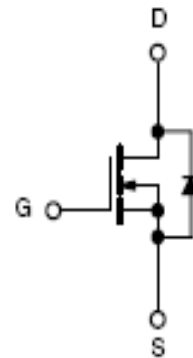
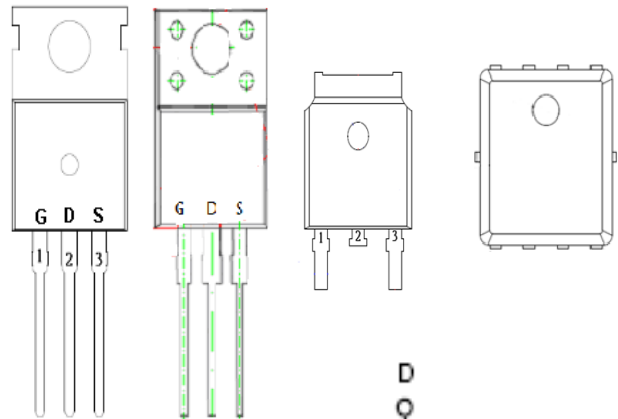
- DC/DC Converter
- Load Switch
- SMPS Secondary Side Synchronous Rectifier
- Motor Control
- Power Tool

FEATURES

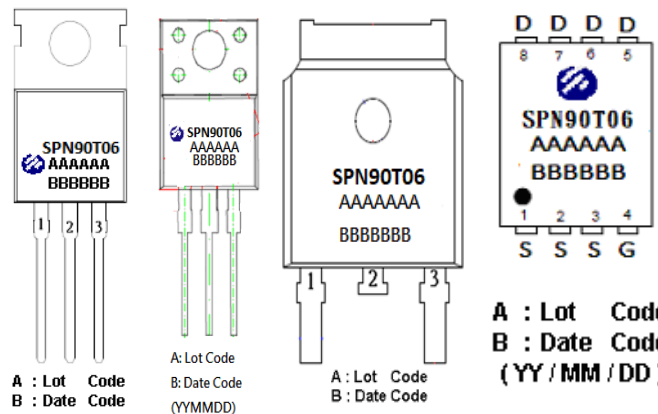
- ◆ 60V/90A, $R_{DS(ON)}=5.3m\Omega@V_{GS}=10V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-220-3L/TO-220F-3L/TO-252-2L/ PPAK5x6-8L package design

PIN CONFIGURATION (PPAK5x6-8L)

TO-220 TO-220F TO-252 PPAK5x6



PART MARKING





SPN90T06

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PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PIN DESCRIPTION (PPAK5x6-8L)

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN90T06T220TGB	TO-220-3L	SPN90T06
SPN90T06T220FTGB	TO-220F-3L	SPN90T06
SPN90T06T252RGB	TO-252-2L	SPN90T06
SPN90T06DN8RGB	PPAK5x6-8L	SPN90T06

- ※ SPN90T06T220TGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN90T06T220FTGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN90T06T252RGB : Tape&Reel ; Pb – Free ; Halogen - Free
- ※ SPN90T06DN8RGB : 13” Tape Reel ; Pb – Free ; Halogen – Free



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ABSOLUTE MAXIMUM RATINGS

(T_A=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit	
Drain-Source Voltage		V _{DSS}	60	V	
Gate –Source Voltage		V _{GSS}	±20	V	
Continuous Drain Current(Silicon Limited)	T _C =25°C	I _D	90	A	
	T _C =100°C		57		
Continuous Drain Current(Package Limited)		T _C =25°C	I _D	60	A
Pulsed Drain Current		I _{DM}	250	A	
Avalanche Energy with Single Pulse (T _C =25°C, L=0.4mH.)		E _{AS}	80	mJ	
Power Dissipation@ T _C =25°C	TO-220	P _D	104	W	
	TO-220F		30		
	TO-252		93		
	PPAK5x6		83		
Operating Junction Temperature		T _J	-55/150	°C	
Storage Temperature Range		T _{STG}	-55/150	°C	
Thermal Resistance-Junction to Case	TO220	R _{θJC}	1.2	°C/W	
	TO220F		4.2		
	TO252		1.35		
	PPAK5x6		1.5		

Note :

The maximum current rating is package limited at 120A for TO-220-3L

The maximum current rating is package limited at 78A for TO-220F-3L

The maximum current rating is package limited at 70A for TO-252-2L

The maximum current rating is package limited at 80A for PPAK5x6-8L



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ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=48V, V_{GS}=0V$			1	uA
		$V_{DS}=48V, V_{GS}=0V$ $T_J=100^\circ C$			100	
Gate Resistance	R_G	$V_{GS}=0V, V_{DS}$ open, $f=1MHz$		1.9		Ω
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=15A$			5.3	m Ω
Forward Transconductance	g_{fs}	$V_{DS}=5V, I_D=20A$		60		S
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$		0.9	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=30V, V_{GS}=10V$ $I_D=20A$		35		nC
Gate-Source Charge	Q_{gs}			11		
Gate-Drain Charge	Q_{gd}			7		
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V$ $f=1MHz$		2207		pF
Output Capacitance	C_{oss}			660		
Reverse Transfer Capacitance	C_{rss}			24		
Turn-On Time	$t_{d(on)}$	$V_{DD}=30V, I_D=20A, V_{GS}=10V$ $R_G=10\Omega$		11		nS
	t_r			7		
Turn-Off Time	$t_{d(off)}$			34		
	t_f			8		



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TYPICAL CHARACTERISTICS

Fig 1. Typical Output Characteristics

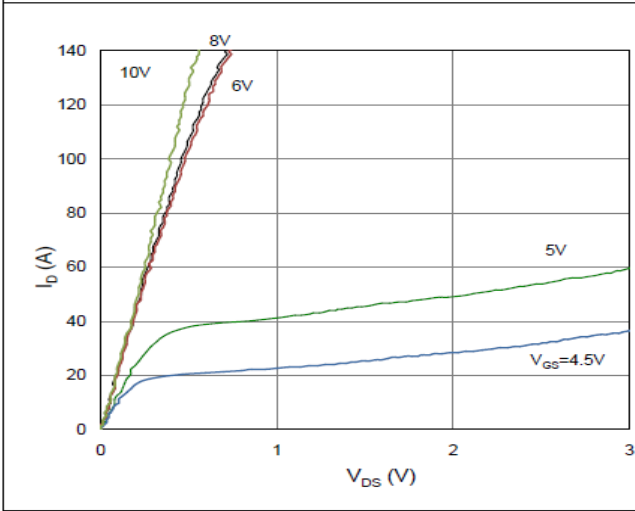


Figure 2. On-Resistance vs. Gate-Source Voltage

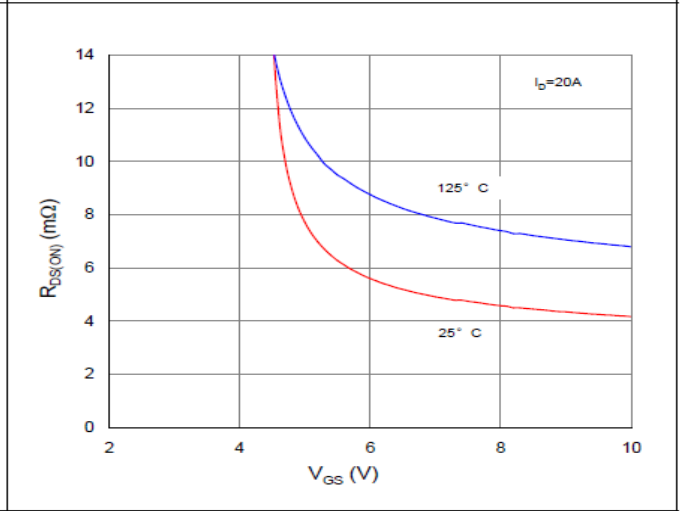


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

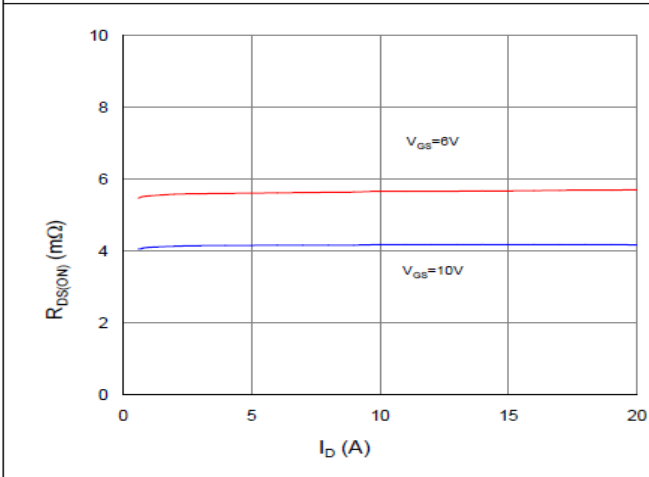


Figure 4. Normalized On-Resistance vs. Junction Temperature

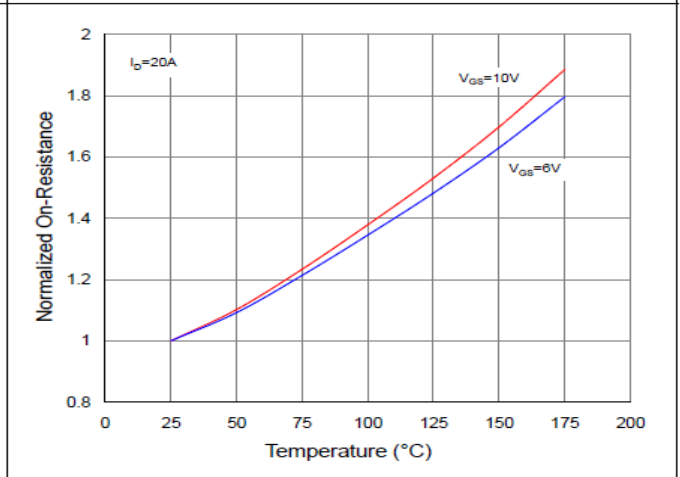


Figure 5. Typical Transfer Characteristics

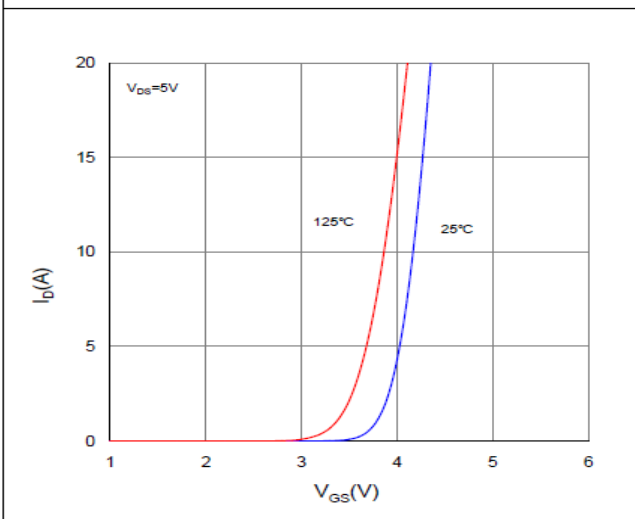
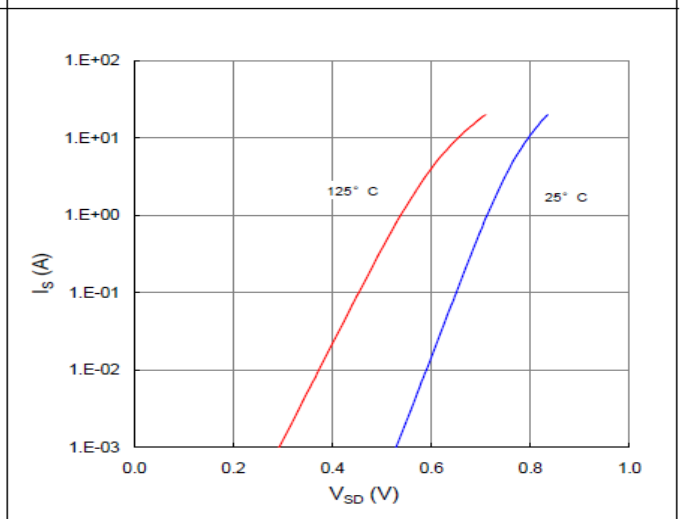


Figure 6. Typical Source-Drain Diode Forward Voltage





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TYPICAL CHARACTERISTICS

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

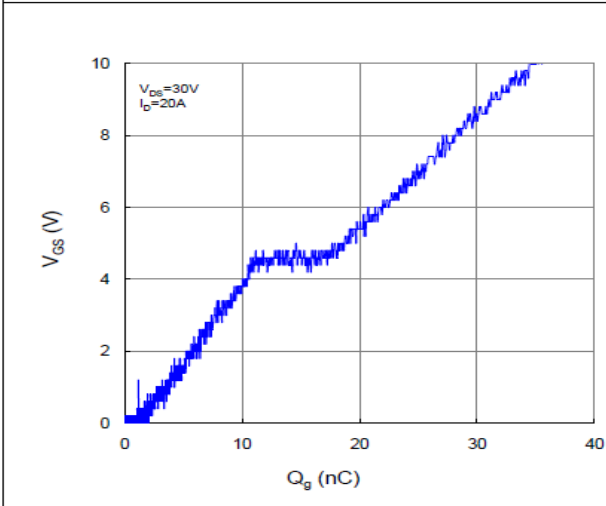


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

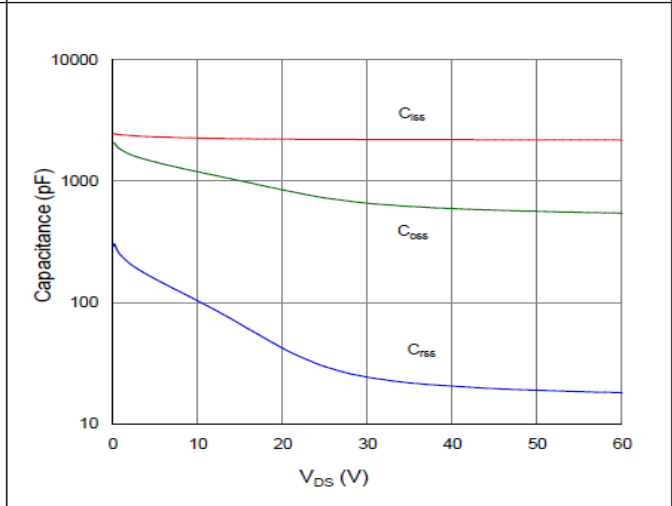


Figure 9. Maximum Safe Operating Area

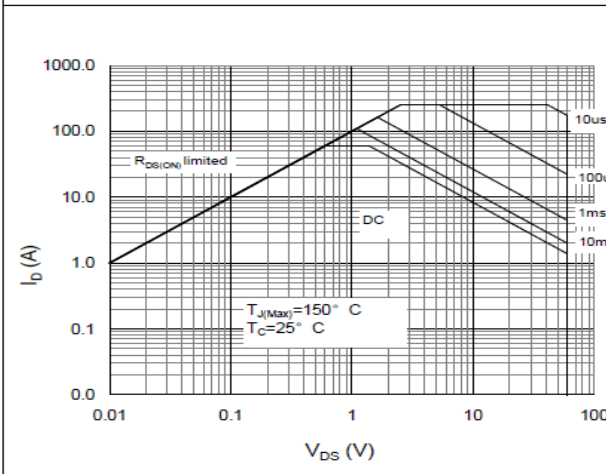


Figure 10. Maximum Drain Current vs. Case Temperature

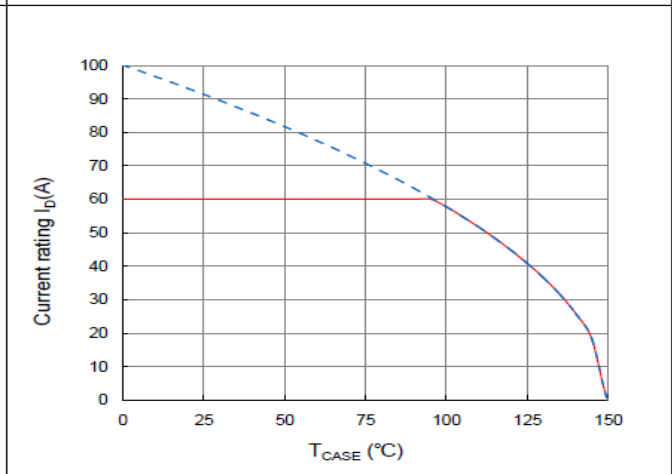
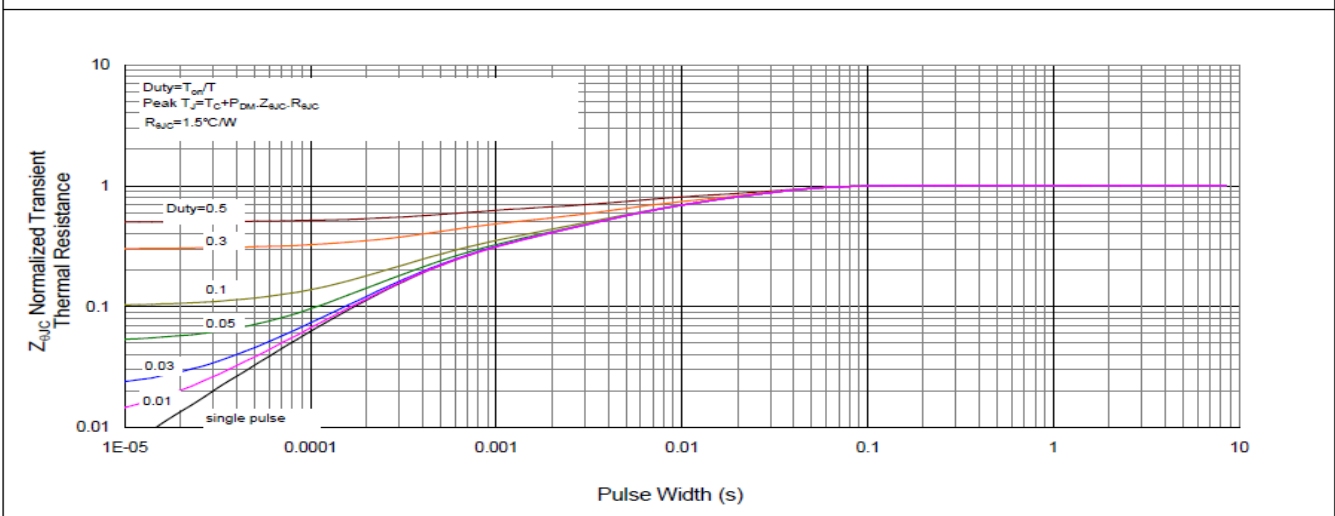


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case





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